**IBIS-AMI Modelling of High- Speed Memory Interfaces** 

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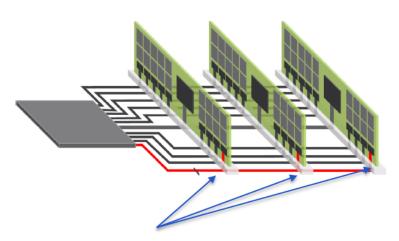




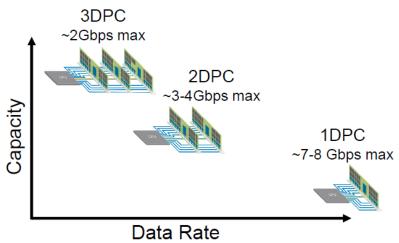
### Motivation

- Memory interfaces are becoming harder to simultaneously meet high capacity requirements while maintaining high bandwidths
- To combat the signal degradations, equalization approaches are utilized (Tx de/preemphasis and Rx AFE & DFE) in conjunction with the traditional selection of ondie termination (ODT) and transmit driver impedance settings
- Leverage IBIS-AMI standards to model high-speed memory interfaces to provide system vendors information
- Present simulation results for 2.4 Gbps and 6.4 Gbps data transmission over the same channel with different equalization features
- Conclusion

# Current DDR Signaling Trend for Datacenter and Enterprise Server Environments



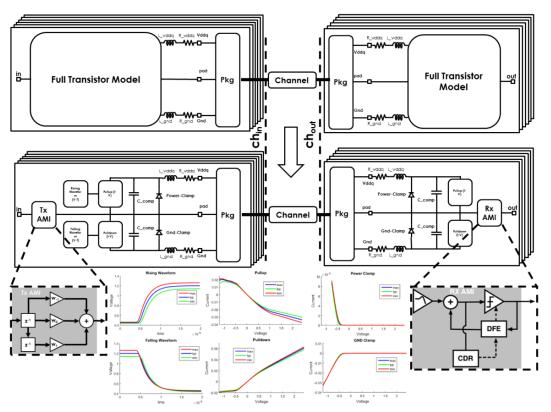
Multi-drop topology of DDR bus causes channel loss, limits speed



#### Fundamental Challenge:

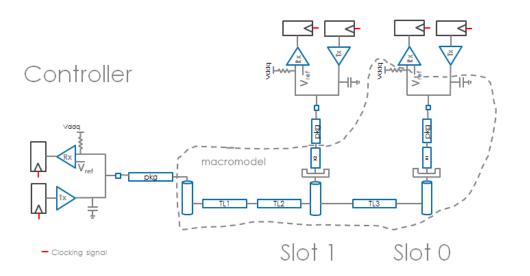
- Higher speed → less capacity per channel
- · Requires more channels to maintain capacity
  - Expensive, pkg/costs hard to scale

#### Overview of IBIS-AMI modelling of high-speed memory interfaces

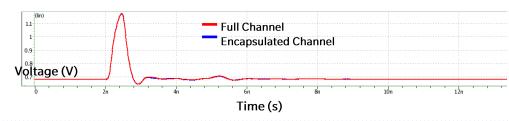


- With shrinking voltage supplies and demand for main stream memory data rates increasing, equalization approaches are necessary to combat noise
- System vendors need models for these interfaces
- IBIS-AMI is an excellent platform for semiconductor/IP vendors and system vendors to exchange information
- Use IBIS-AMI standards with electrical response captured by .ibs and the behavioral response captured by .ami (& .dll / .so)

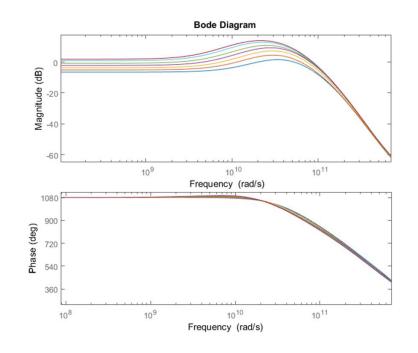
## **Encapsulating Multi-drop Passive Memory Channel**



- AMI is really developed for pointto-point transmission (SerDes links)
- To enable the modelling of multidrop, passive memory channels, the channel now includes the ODT of the peripheral channel
- Macromodel/S-parameter is then incorporated into the link simulation



## System Identification of Analog Front End



- Used system identification to extract the poles and zeros of the transfer function from the AFE from SPICE simulations
- H(s) -> H(z) through bilinear transform to discretize the transfer function which is subsequently integrated into the .ami portion of the receiver

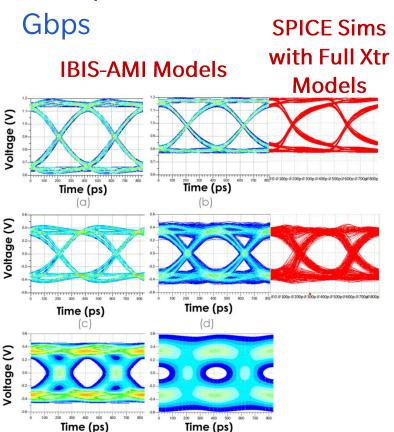
$$z = e^{s \cdot T_s} = e^{2\pi \cdot jf \left( UI /_{OSR} \right)}$$

## Example of IBIS-AMI file format

```
Tx.ibs
[Model] DQ RON34
Model type
              Output
                                   max
C comp
                  1.159pF
                               1.143pF
                                           1.195pF
[Voltage Range]
                    1.200V
                                 1.140V
                                             1.260V
[Temperature Range] 25.0
                                  85.0
                                            0.0
[Algorithmic Model]
Executable Linux_gcc4.9.1_64 TX_glnxa64.so TX.ami
[End Algorithmic Model]
Tx.ami
(Model Specific
  (txFirT1 (Usage In) (Type Float) (Format Range -0.11 -0.22 1.0) (Default -0.11))
 (txFirT2 (Usage In) (Type Float) (Format Range 0.89 0.78 1.0) (Default 0.89))
  (txFirT3 (Usage In) (Type Float) (Format Range -0.11 -0.22 1.0) (Default -0.11))
Rx.ibs
[Model] DQ ODT 60
Model type
              Input
                                   max
                              1.143pF
C comp
                  1.159pF
                                           1.195pF
                    1.200V
                                 1.140V
                                             1.260V
[Voltage Range]
[Temperature Range]
                      25.0
                                  85.0
                                            0.0
[Algorithmic Model]
Executable Linux acc4.7.2 64 RX alnxa64.so RX.ami
[End Algorithmic Model]
[GND Clamp]
Rx.ami
(Model Specific
 (ctleModeSelect (Usage In) (Type Float) (Format Range 4.0 1.0 8.0) (Default 4.0))
 (VGAGain (Usage In) (Type Float) (Format Range 3.0 1.0 6.0) (Default 3.0))
  (dfeT1 (Usage In) (Type Float) (Format Range -0.038 -0.2 0.2) (Default -0.038))
 (dfeT2 (Usage In) (Type Float) (Format Range -0.084 -0.2 0.2) (Default -0.084))
```

- Here shows a typical format of the .ibs file which acts as the wrapper to call the .ami file along with the .so / .dll file
- ibs wrapper are the electrical LUTs which define the nonlinearities of the electrical Tx and Rx impedance
- package model is typically extracted through electromagnetic simulations and will have an RLC or Sparameter format
- temperature and voltage ranges along with the input capacitance (C\_comp) are defined
- .ami contains the variables which pass to the .dll or .so file along with the value range.
- Matlab/Simulink was used to model and encode the AMI portion of the macromodel along with Microsoft's Visual Studio for C++ code development and GNU Compiler Collection (GCC)

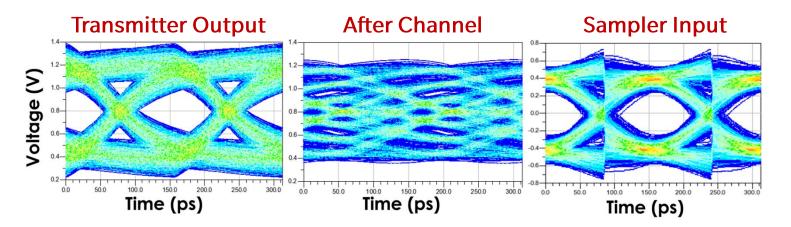
## Example of Tx and Rx modelled with IBIS-AMI operating at 2.4



- For 2.4 Gbps operation, only the Rx has CTLE equalization with the transmit eye diagram plotted with two different ODT<sub>1,2</sub> settings as shown in (a-b) before the CTLE without crosstalk whose reference voltage is adjusted to conform with single-ended (SE) pseudo-open drain logic (PODL) signaling typical of DDR4
- (c-d) shows the eye diagram after the CTLE where the SE signal is converted to a differential signal resulting with a reference voltage of 0 V with and without crosstalk, respectively
- (e-f) show eye diagram with the inclusion of the random noise (RJ) and RJ plus voltage noise at the Rx, respectively
- A comparison of the simulation time and EH / EW is shown in the below table indicating that IBIS-AMI models fairly represent the results of full-transistor models with a simulation time improvement of over 1000x the CPU time speed.

	Full-Transistor	IBIS-AMI
Simulation Time	191.6 min	0.148 min
Accuracy	High	Med
At pad w/ ODT <sub>2</sub>	EW = 387  ps,	EW = 375  ps,
	EH = 290  mV	EH = 295  mV
w/o xtalk after	EW = 383  ps,	EW = 360  ps,
CTLE	EH = 581  mV	EH = 580  mV
w/ xtalk after	EW = 341  ps,	EW = 338  ps,
CTLE	EH = 454  mV	EH = 480  mV

# Example of Tx and Rx modelled with IBIS-AMI operating at 6.4 Gbps



- For advanced memory interfaces operating beyond DDR4, a DFE may be necessary to overcome postcursor distortion associated with multi-drop topologies typical of high capacity, memory channels for server applications
- As a demonstration of equalization effects, a two-tap DFE is used to open the eye at 6.4 Gbps using single-ended PODL signaling

### Conclusion

- As demand for main stream memory data rates increase, equalization approaches are necessary with shrinking voltage supplies and stagnant channel performance
- System vendors need models for these interfaces
- IBIS-AMI is an excellent platform for semiconductor/IP vendors and system vendors to exchange information
  - Expand application of IBIS-AMI standard for high-speed memory interfaces
  - Challenges include enabling IBIS-AMI for single-ended transmit/receiver and the accurate calculation of the DC value
- References:
- Yan, J., Zaragaran-Yazd, A., "IBIS-AMI Modelling of High-Speed Memory Interfaces," 24th Conference on Electrical Performance of Electronic Packages and Systems, San Jose, CA - October 25-28 2015.